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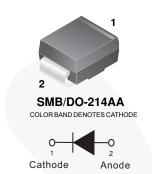


January 2016

# S3AB - S3MB 3 A, 50 V - 1000 V Surface Mount Rectifiers

### **Features**

- · Glass Passivated Chip Junction
- · High Surge Current Capacity
- Low Forward Voltage: 1.15 V Maximum
- UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- · RoHS Compliant / Green Molding Compound
- Industrial Device Qualified per AEC-Q101 Standards
  - \* See authorized use policy



# **Ordering Information**

Part Number	Top Mark	Package	Packing Method
S3AB	S3AB	DO-214AA (SMB)	Tape and Reel
S3BB	S3BB	DO-214AA (SMB)	Tape and Reel
S3DB	S3DB	DO-214AA (SMB)	Tape and Reel
S3GB	S3GB	DO-214AA (SMB)	Tape and Reel
S3JB	S3JB	DO-214AA (SMB)	Tape and Reel
S3KB	S3KB	DO-214AA (SMB)	Tape and Reel
S3MB	S3MB	DO-214AA (SMB)	Tape and Reel

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value						Unit	
Symbol	Farameter		S3BB	S3DB	S3GB	S3JB	S3KB	S3MB	Oilit
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage		100	200	400	600	800	1000	V
V <sub>RMS</sub>	RMS Reverse Voltage	35 70 140 280 420 560 700		700	V				
V <sub>R</sub>	DC Blocking Voltage	50 100 200 400 600 800 1000		1000	V				
I <sub>F(AV)</sub>	Average Forward Rectified Current				3				Α
I <sub>FSM</sub>	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load				80				А
TJ	Operating Junction Temperature Range			-5	55 to +15	50			°C
T <sub>STG</sub>	Storage Temperature Range	Range -55 to +150			°C				

## Thermal Characteristics(1)

Values are at T<sub>A</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Typical Thermal Resistance, Junction-to-Ambient	148	°C/W
ΨJL	Typical Thermal Characteristics, Junction-to-Lead	14	°C/W

### Note:

1. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm per JESD51-3.

### **Electrical Characteristics**

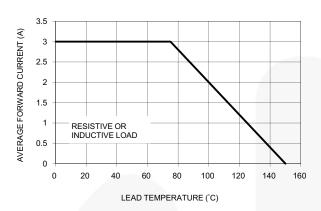
Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
$V_{F}$	Instantaneous Forward Voltage <sup>(2)</sup>	I <sub>F</sub> = 3 A			1.15	V	
I <sub>R</sub>	Reverse Current at Rated V <sub>R</sub>	T <sub>J</sub> = 25°C			10	μA	
		T <sub>J</sub> = 125°C			250	μΑ	
T <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A, I <sub>rr</sub> = 0.25 A		1.5		μs	
CJ	Junction Capacitance	V <sub>R</sub> = 4 V, f = 1 MHz		40		pF	

### Note:

2. Pulse test with PW =  $300 \mu s$ , 1% duty cycle

# **Typical Performance Characteristics**



**Figure 1. Forward Current Derating Curve** 

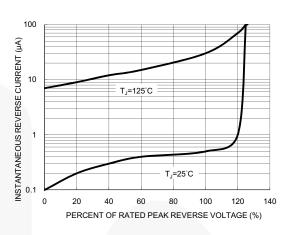


Figure 2. Typical Reverse Characteristics

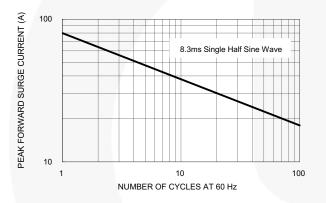


Figure 3. Maximum Non-Repetitive Forward Surge Current

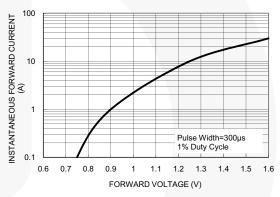


Figure 4. Typical Forward Characteristics

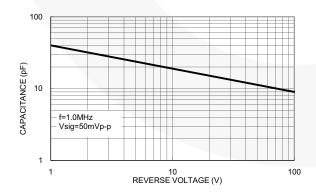


Figure 5. Typical Junction Capacitance

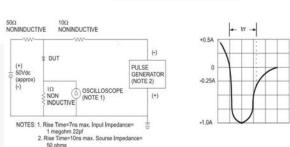
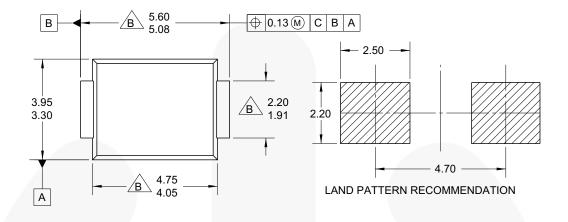
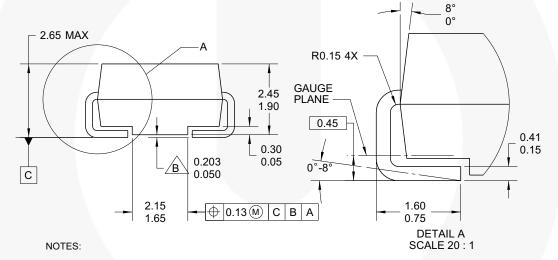


Figure 6. Reverse Recovery Time Characteristic and Test Circuit Diagram

# **Physical Dimensions**





- A. EXCEPT WHERE NOTED CONFORMS TO
  JEDEC DO214 VARIATION AA.
  B DOES NOT COMPLY JEDEC STD. VALUE.
  C. ALL DIMENSIONS ARE IN MILLIMETERS.
  D. DIMENSIONS ARE EXCLUSIVE OF BURRS,
  MOLD FLASH AND TIE BAR PROTRUSIONS.
  E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
- LAND PATTERN STD. DIOM5336X240M.
- G. DRAWING FILE NAME: DO214AAREV1

Figure 7. 2-LEAD, SMB, JEDEC DO-214, VARIATION AA



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Definition of Terms					
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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.			
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